

Session Program

30 May 2016 to 3 June 2016

10th International Meeting on Front-End Electronics (FEE 2016)

3D integration

AGH University of Science and Technology
Academic Centre for Materials and Nanotechnology Bldg. D-16 Kawiory St. 30 30-055 Krakow, Poland

Wednesday 1 June

14:00

3D integration

Session |

Location: AGH University of Science and Technology, Academic Centre for Materials and Nanotechnology Bldg. D-16
Kawiory St. 30 30-055 Krakow, Poland |

Convener: Piotr Maj

14:00-14:25

The 3D digital SiPM for nEXO**Speaker**

Jean-Francois Pratte

14:25-14:50

3D integration technology - status**Speaker**

Grzegorz Deptuch

14:50-15:15

VIPIC-Large 3D pixel readout for XPCS**Speaker**

Farah Fahim

15:15